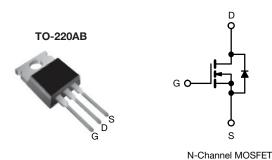


Power MOSFET



| PRODUCT SUMMARY | | | | | |
|----------------------------|-------------------------|--------|--|--|--|
| V _{DS} (V) | 100 | 100 | | | |
| R _{DS(on)} (Ω) | V _{GS} = 5.0 V | 0.54 | | | |
| Q _g (Max.) (nC) | 6.1 | | | | |
| Q _{gs} (nC) | 2.6 | 6 | | | |
| Q _{gd} (nC) | 3.3 | 3.3 | | | |
| Configuration | Sino | Single | | | |

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- · Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- 175 °C operating temperature
- · Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION | | | |
|---------------------------------|---------------|--|--|
| Package | TO-220AB | | |
| Lead (Pb)-free | IRL510PbF | | |
| Lead (Pb)-free and halogen-free | IRL510PbF-BE3 | | |

| ABSOLUTE MAXIMUM RATINGS (TC | = 25 °C, un | less otherwis | se noted) | | | |
|--|--------------------------|---|-----------------------------------|-------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | | | V_{DS} | 100 | V | |
| Gate-source voltage | | | V_{GS} | ± 10 | | |
| Continuous drain current | V _{GS} at 5 V | $T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$ | , | 5.6 | | |
| | V _{GS} at 5 V | T _C = 100 °C | I _D | 4.0 | Α | |
| Pulsed drain current ^a | | | I _{DM} | 18 | | |
| Linear derating factor | | | | 0.29 | W/°C | |
| Single pulse avalanche energy b | | | E _{AS} | 100 | mJ | |
| Repetitive avalanche current a | | | I _{AR} | 5.6 | Α | |
| Repetitive avalanche energy ^a | | | E _{AR} | 4.3 | mJ | |
| Maximum power dissipation | T _C = | 25 °C | P_{D} | 43 | W | |
| Peak diode recovery dV/dt c | | | dV/dt | 5.5 | V/ns | |
| Operating junction and storage temperature range | | | T _J , T _{stg} | -55 to +175 | - °C | |
| Soldering recommendations (peak temperature) d | e) ^d For 10 s | | 300 ^d | | | |
| Mounting torque | 6-32 or M3 screw | | | 10 | lbf ⋅ in | |
| | | | | 1.1 | N⋅m | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 4.8 mH, R_a = 25 Ω , I_{AS} = 5.6 A (see fig. 12)
- c. $I_{SD} \le 5.6 \text{ A}$, $dI/dt \le 75 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \text{ °C}$
- d. 1.6 mm from case



Vishay Siliconix

| THERMAL RESISTANCE RATINGS | | | | | |
|-------------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum junction-to-ambient | R _{thJA} | - | 62 | | |
| Case-to-sink, flat, greased surface | R _{thCS} | 0.50 | - | °C/W | |
| Maximum junction-to-case (drain) | R _{thJC} | - | 3.5 | | |

| DADAMETED | CVMDOL | TEC | TOONDITIONS | BAINI | TVD | MAN | LINUT |
|---|-----------------------|--|--|-------|------|----------|-------|
| PARAMETER | SYMBOL | IES | T CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| Static | | 1 | | | ı | | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 100 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | + | e to 25 °C, I _D = 1 mA | - | 0.12 | - | V/°C |
| Gate-source threshold voltage | $V_{GS(th)}$ | | V_{GS} , $I_{D} = 250 \mu A$ | 1.0 | - | 2.0 | V |
| Gate-source leakage | I _{GSS} | V _{GS} = ± 10 V | | - | - | ± 100 | nA |
| Zero gate voltage drain current | I _{DSS} | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ | | - | - | 25 | μA |
| Zoro gato voltago dram oumont | 1033 | $V_{DS} = 80 \text{ V},$ | V _{GS} = 0 V, T _J = 150 °C | - | - | 250 | μΛ |
| Drain-source on-state resistance | R _{DS(on)} | $V_{GS} = 5.0 \text{ V}$ | $I_D = 3.4 \text{ Ab}$ | - | - | 0.54 | Ω |
| Diani-Source on-State resistance | 1 (DS(on) | $V_{GS} = 4.0 \text{ V}$ | $I_D = 2.8 A^b$ | - | - | 0.76 | |
| Forward transconductance | 9fs | V _{DS} = 50 V, I _D = 3.4 A ^b | | 1.9 | - | - | S |
| Dynamic | | | | | | | |
| Input capacitance | C _{iss} | $V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. } 5$ | | - | 250 | - | pF |
| Output capacitance | C _{oss} | | | - | 80 | - | |
| Reverse transfer capacitance | C _{rss} | | | - | 15 | - | |
| Total gate charge | Qg | | | - | - | 6.1 | nC |
| Gate-source charge | Q _{gs} | V _{GS} = 5.0 V | $I_D = 5.6 \text{ A}, V_{DS} = 80 \text{ V}$ see fig. 6 and 13 ^b | _ | - | 2.6 | |
| Gate-drain charge | Q _{gd} | 1 | see lig. 6 and 13 | _ | - | 3.3 | |
| Turn-on delay time | t _{d(on)} | | | - | 9.3 | - | |
| Rise time | t _r | $V_{DD} = 50 \text{ V}, I_{D} = 5.6 \text{ A}$ $R_{g} = 12 \Omega, R_{D} = 8.4 \Omega$ see fig. 10^{b} | | - | 47 | - | - ns |
| Turn-off delay time | t _{d(off)} | | | - | 16 | - | |
| Fall time | t _f | | | - | 18 | - | |
| Internal drain inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | 211 |
| Internal source inductance | L _S | | | - | 7.5 | - | - nH |
| Drain-Source Body Diode Characteristic | es | | | | | | |
| Continuous source-drain diode current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 5.6 | _ |
| Pulsed diode forward current ^a | I _{SM} | | | - | - | 18 | A |
| Body diode voltage | V _{SD} | T _J = 25 °C, I _S = 5.6 A, V _{GS} = 0 V ^b | | - | - | 2.5 | V |
| Body diode reverse recovery time | t _{rr} | T _J = 25 °C, I _F = 5.6 A, dl/dt = 100 A/μs ^b | | - | 110 | 130 | ns |
| Body diode reverse recovery charge | Q _{rr} | | | _ | 0.50 | 0.65 | μC |
| Forward turn-on time | t _{on} | | ı-on is dor | l | | <u> </u> | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

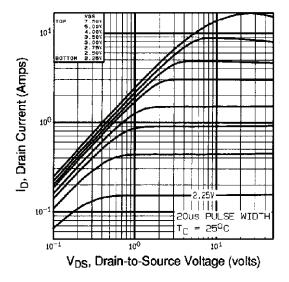


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

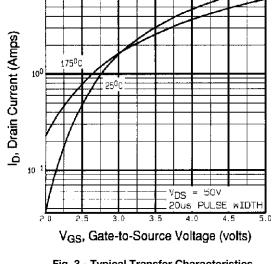


Fig. 3 - Typical Transfer Characteristics

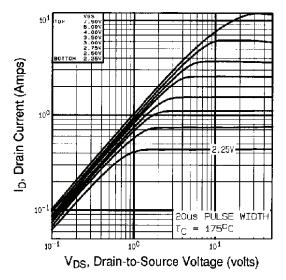


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

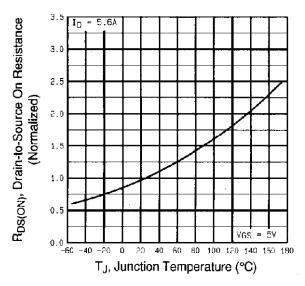


Fig. 4 - Normalized On-Resistance vs. Temperature



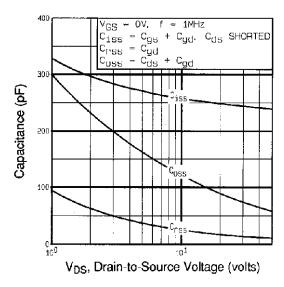


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

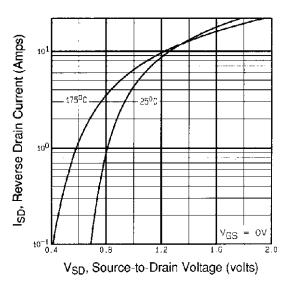


Fig. 7 - Typical Source-Drain Diode Forward Voltage

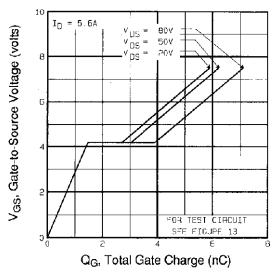


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

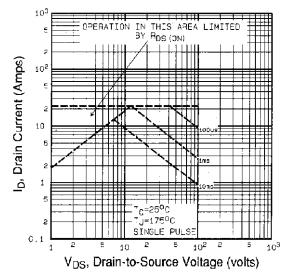


Fig. 8 - Maximum Safe Operating Area



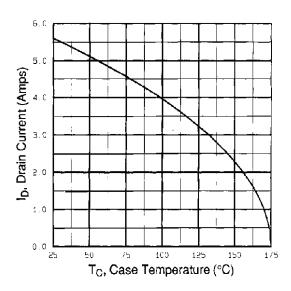


Fig. 9 - Maximum Drain Current vs. Case Temperature

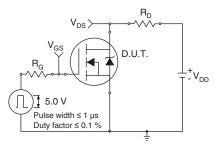


Fig. 10a - Switching Time Test Circuit

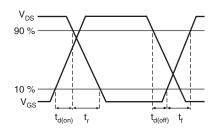


Fig. 10b - Switching Time Waveforms

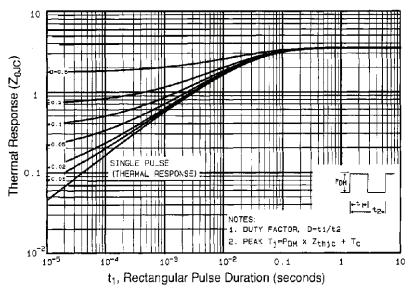


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



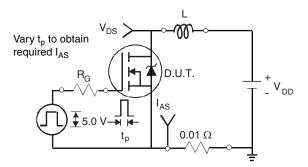


Fig. 12a - Unclamped Inductive Test Circuit

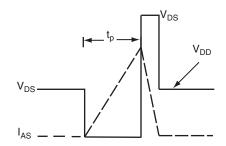


Fig. 12b - Unclamped Inductive Waveforms

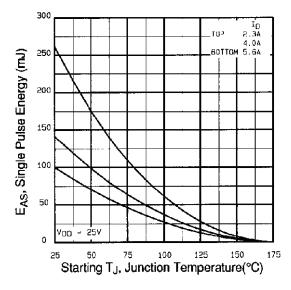


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

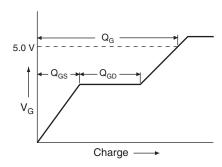


Fig. 13a - Basic Gate Charge Waveform

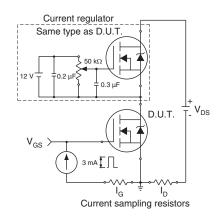
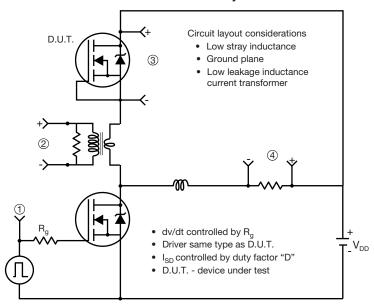


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



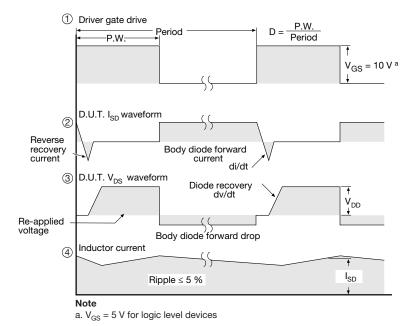


Fig. 14 - For N-Channel

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